**ELECTROMECHANICAL** CONTACT



DIN standards Single, multiple, fine, ultra-fine wire Single, double, triple coloured Insulation: PVC/PE/TPE/silicone/ Chain terminals 2.8-4.8-6.3-7.7-9.3mm PP/PA Tefzel/Teflon/PUR/ Glass filament/EVA etc. Halogen free/flame-resistant/lead-free

approvals Temperature range: -200°C to 1200°C

Wire to PCB connectors PCB to PCB connectors Wire to wire connectors Jumpers Memory cards and PCMCIA connectors Serial, parallel, USB Wide range of terminals Strips and cables

Customized harness

#### HARNESS MAKING, ASSEMBLING, MACHINES AND TOOLS

# Harness making

Crimping all typical connectors, half or full automatic process **Cutting and stripping** from AWG32(0,05 mm<sup>2</sup>) up to AWG8 (8,00 mm<sup>2</sup>) Lead free tin plating

#### Machines for:

Automotive connectors

Ring tongue and other

RAST connectors 2.5 and 5.0

solderless terminals and splices

Benchtop Crimping & Stripping **Full Process Crimping** Marking

Cutting to Length & Stripping Prefeeding Coiling/Collection Spare parts

### Applicators -**Presses**

for all types of connectors

Other tools & applicators for RAST connectors Applicators for:

JST, LEAR, TYCO, JAE, FCI Testing tools

- Design-in support well trained engineers are providing high
- years of experience

- Access to more than 100 suppliers

# Industrial 29% Embedded 5%

# WEZAG

#### SERVICES FOR OEMS AND CEMS IN EASTERN EUROPE

- quality service
- Sample supply and product info high level and many
- Trainings common actions with our franchise
- Programming of oscillators, ICs, etc Harness making according to specification
- Supply of more than 500 000 components
- EDI, e-commerce on www.microdis.net
- Online Order Tracking ■ Consignment stock: central as well as local

Long-term cooperation with customers covering all industrial segments

Supply of small quantities by catalogue distribution

# **Microdis** Innovation & Reliability

mania@microdis.net

ussia@microdis.net

erbia@microdis.net

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urkey@microdis.net

\*Electromechanical Competence Center for France

ovenia@microdis.net



www.microdis.net

#### **25 YEARS OF MICRODIS ELECTRONICS**

eading in Eastern Europe as technical broadline distributor of electronic components, logistic provider and always reliable partner for suppliers and customers.

#### MICRODIS BUSINESS MODEL

- Franchise Distribution for a selected number of manufacturers
- **Special Mass Market Distribution** by Internet and Catalogue









#### DEVELOPMENT STEPS OF THE MICRODIS ELECTRONICS GROUP

Foundation of the companies in Hungary and Germany

1990 Foundation of sales companies in Poland and Slovakia

First deliveries to the industry

1992 Foundation of LSB Electronics later renamed to Microdis Plus Poland

Restructuring from retail to distribution

1993 Foundation of Microdis KFT in Hungary 1995 Consolidation of all companies within the Eurodis Microdis Holding AG in Switzerland (60% Eurodis [later Eurodis Electron PLC] and 40% Microdis)

Foundation of a subsidiary in Czech Republic 2000 Europartners Consultants proclaimed Eurodis Microdis No. 1 in Poland and

No. 3 in Hungary. Start of catalogue distribution 2003 Microdis sells its 40% shares of the Eurodis Microdis Electronics AG to

Eurodis Electron PLC and takes over entirely Eurodis Microdis Electronics in Germany

2006 Microdis obtained ISO 9001:2000 Certification 2007 Foundation of Microdis in Ukraine

2008 Foundation of Microdis in Latvia

2009 Foundation of Microdis in Bulgaria

2010 Microdis Group obtained ISO 9001/2008 Certification 2011 Foundation of Microdis Components Elektronik in Turkey (Istanbul)

2012 Logistic Center moved to the acquired building in Hockenheim, Germany

2013 Inauguration of Electromechanical Competence Center for France, in Sarrebruck

25 years on the Eastern European market was truly a time of "Innovation and Reliability" that we are very proud of, and very grateful to all of our partners and friends. We look forward to a bright future together.

Microdis Electronics Team



oland@microdis.net

**Microdis** 

Innovation & Reliability



#### State of the art GNSS modules

based on the latest technology u-bloxM8 Form factors: MAX, NEO, LEA, EVA, PAM, CAM Modules are qualified for in vehicle use (ISO16750) High performance GNSS receivers, sensitivity: -167dBm Flexible modes, fe: GPS, Glonass, GPS+Glonass parallel Extremely low power: 4.5mA/3V (fix GPS every 1s) Position accuracy (CEP, SBAS): 2.0m Built in active antenna support (power, monitor)

High in-band jamming immunity, Jammer detection Assisted GNSS: GPS as well as Glonass supported AssistNow Online, Offline and Autonomous modes Direct cooperation with GSM/UMTS modules PPP support – accuracy better than 1.0m (2D,R50) Modules with built in sensors (gyroscope, accelero.) Dedicated modules for timing, RAW data

Miniature modules with built-in antenna (CAM-M8Q)



Miniature GPS+Glonass module with built-in antenna (9.6x14.0x1.95mm)

u-blox8/7/6/5 modules are pin compatible

## WIRELESS ACCESSORIES

GSM. GPS. GLONASS. Iridium. WiFi, ISM antennas Helical GPS & GLONASS antennas L1 & L2 band antennas





#### Reliable, field proven

GPS/Glonass/BeiDou/QZSS and GSM/UMTS/LTE modules

High performance GSM, UMTS, CDMA, LTE modules

Navigation without GPS, based on GSM network eCall ready products with in-band modem Available in compact, SMT form factors Wide temperature range -40°C to +85°C





#### LEON-G1. SARA-G3 - GSM/GPRS modules

Embedded TCP/UDP/IP. FTP/HTTP/SMTP stack ATEX certificate to be used in explosive environments

Low cost versions (2 GSM bands) Low power consumption (<0.6mA idle, 2.9mA active mode) Built-in Assisted GNSS client to support GNSS modules Multiple socket & IP addresses

DTMF support, SIM card detection Small form factor 16.0x26.0x3.0mm One PCB design for GSM and UMTS modules Simple integration with u-blox' GNSS modules

#### SARA-U2 family of compact GSM/UMTS/HSPA modules

Form factor as small as 16.0x26.0x3.0mm Pin compatible to GSM/GPRS module SARA-G3 New Low cost version available (UMTS only, no GSM support) Low power consumption

GSM/UMTS/HSPA+ modules

HSDPA (21.1Mb/s), HSUPA (5.76Mb/s) Worldwide module All 3G (six) and 2G (four) bands support 3G: 800/850/900/1700/1900/2100MHz LISA family:WCDMA USB 2.0, SPI, UART

#### **TOBY - LTE modules**

TOBY-L1 – LTE only support TOBY-L2 - GSM/GPRS/HSPA+/LTE Up to 150Mb/s data rate Voice over LTE

The smallest UMTS module:

SARA-U2, pin compatible

to SARA-G3 (GSM)

ested design available at u-blox, SARA, LISA or TOBY can be alternatively mounted on the same PCB

The use of u-blox modules does not lead to consequences from infringement of patents and copyrights.

#### ISM PRODUCTS

#### Wireless M-Bus modules and devices 868MHz and 169MHz

AMBER WIRELESS for metering applications Zigbee modules up to 4.5dBm power

Modules, Modems & USB Dongles for 868MHz, 169MHz, 2.4MHz

Certified industrial Bluetooth modules and Stacks BT 2.1, 3.0 and BT 4.1 (BLE), Class 1 & 2, also dedicated modules for medical applications (HDP

compliant with IEEE 11073) Multiradio modules

Wi-Fi, Classic BT and BT 4.0 (BLE) combined in one host based module



MR8426-M & AMR8466 Wireless M-Bus module and bridge



stol/mann



ISO Cards, Key Fobs, Wrist Bands, PET laminates RFID system solutions for:Access control, Animal indentification(Pet, bird and livestock), Industry and logistic (also KEG and waste ID)

#### Reliable interconnect products

aloba dumentar estaduação

# SIM / Nano SIM / Pico SIM connectors

Memory Card Connectors USB Connectors Board to board connectors FFC connectors Dedicated white

connectors for LED boards



#### INDUSTRIAL COMPUTING PRODUCTS



#### In-vehicle computers and displays

Wireless communication: GPS, GSM, WLAN Flexible ignition control, easy adoption to car power-systems High vibration resistance, wide operating temperature Additional IP65 housing

#### **Full HD Digital Signage Solutions**

Wide range of industrial players designed for 24/7 operation Perfect graphic performance, various video outputs Single, dual, triple and quad display possibility

#### Panel PCs and fanless box computers for automation industry

Compact sizes, low power consumption Many options of I/O interfaces, high reliability Embedded OS, watchdog built-in, long life





IP67 Panel PCs. Industrial displays. Embedded boards Fanless with Intel, VIA and AMD CPUs, RISC Different form factors: FSB. HSB. 3.5", 5.25", PC/104 EPIC. ETX. ITX. XTX. COM. Oseven

### /ISRock



#### Cost-effective and reliable mini-ITX boards

Intel Atom/i3/i5/i7 and AMD G-series platforms Industrial design 5 Years life cycle support





#### 32 - 65" Large Format Displays with Touchscreen

Fanless, great viewing angles and exceptional color clarity, wide range of video and audio nputs, dedicated space for multimedia player mounting at the rear

#### LIGHTING PRODUCTS



of one module up to 1450lm (17.5W), and up to 140lm/W efficacy (10W module)

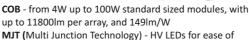


Z-POWER LED - super bright power LEDs. Efficacy up to 160lm/W SIDE, TOP, CHIP, LAMP - available as through hole and SMD, ultrabright, multicolor, full-color (RGB), efficacy of 5630D LED up to 200lm/W (@65mA)









power (i.e.5050) packages available

#### Japanese Power LEDs, SMD and THT 155lm/W with CCT 5000K

Power LEDs with high CRI (up to 95) 2000K for mood lighting LEDs for automotive market, IR LEDs





# Wide portfolio of signalling LEDs

Double color (warm + cool) power LEDs Standard form factors 12W-36W (9090) 4-chip power LEDs Power LED matrix modules

#### **Customized solutions**

LED modules: square and round modules in different sizes LED strips













up to 11800lm per array, and 149lm/W MJT (Multi Junction Technology) - HV LEDs for ease of design, cost effective mid-power (i.e. 5630) and high





# Taiwanese cost-effective LEDs

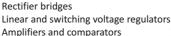
Acrich modules



# SEMICONDUCTOR

#### High quality semiconductors

Transient Voltage Suppressors Zener and switching diodes Rectifier diodes





78(9)xx, 78(9)Lxx, LM317, LM339, LM358, LM431, LM810, SMAJ, SMBJ, SMCJ, P4KE, P6KE, 1,5KE, BAV, BAS, BAT and many others



#### Timing and Sensing quartz based devices

Crystal units kHz Range MHz Range

#### SAW Resonators Oscillators

SPXO kHz & MHz range TCXO VCXO

SAW Oscillators



#### Gyro sensors

**Programmable Oscillators** Customer specified frequency (1.000MHz to 166.000MHz) Customer specified logic (5V, 3.3V, 2.5V, 1.8V) 10 sizes available including THT, SMD plastic

#### package or SMD ceramic package Available within 24h from stock!



QMEMS is a combination of 'Quartz', a crystal material with excellent characteristics such as high stability and high precision, and "MEMS" (a microfabrication technology). To a semiconductor MEMS material, EPSON applies precision microprocessing based on quartz material to create a quartz device called 'QMEMS' which offers high performance in a compact package.



#### assembly solutions

#### Generic connectors

Core Series - Brass connectors AluLite™ Series – Aluminum connectors Plastic Series - Plastic connectors **Specific Connecors** 

Nim-Camac - Coax and Triax Connectors Disposable - Low cost, high performance connectors SD/HD Camera connectors – Triax or Fiber Optic

UltiMate<sup>™</sup> - high performance military connectors



#### Wide range of electromechanical solutions **Tact Switches**

Snap-in types available in 4.5x4.5mm to 12x12mm sizes

Surface Mount types available in 2.8x2.4mm to 10x10mm sizes Sharp and Soft feeling types

Multiple operating force versions (stem color coding) Dust proof & water proof versions

#### available Encoders

Rotary and slide potentiometers, industrial and pro-audio types available

#### Multicontrol Devices

Memory and SIM card connectors also dedicated for automotive market

#### Detector switches

Power Switches

Magnetic, MEMS and capacitive sensors

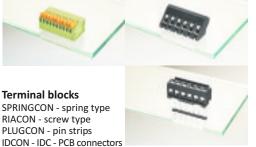
Thermal Printers



# Push-pull circular connectors and cable



SPRINGCON - spring type RIACON - screw type PLUGCON - pin strips IDCON - IDC - PCB connectors



METZ

CONNECT

# relektronik 🛂 📑

#### Heatsinks

Machined extruded heatsinks Heatsinks for LEDs Extruded heatsinks with retaining springs for PCE mounting

Heatsinks and fan coolers for processors, PGA & BGA components

Cooling aggregates Thermal conductive materials

Miniature aluminum cases Combination cases Desk consoles and shell cases 19" system cases

#### Connectors

Hi precision board-to-board connectors IDC connectors D-SUB connectors DIL PGA. PLCC sockets

#### Services

Precision CNC machining of heatsinks, cases, front panels

Powder coating Screen printing YAG laser engraving











